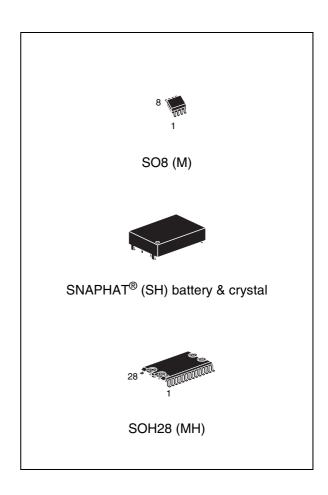


## Serial real-time clock with 56 bytes of NVRAM

### **Features**

- Counters for seconds, minutes, hours, day, date, month, years and century
- 32 KHz crystal oscillator integrating load capacitance (12.5 pF) providing exceptional oscillator stability and high crystal series resistance operation
- Serial interface supports I<sup>2</sup>C bus (100 kHz protocol)
- Ultra-low battery supply current of 0.8 µA (typ. at 3 V)
- 2.0 to 5.5 V clock operating voltage
- Automatic switchover and deselect circuitry
- 56 bytes of general purpose RAM
- Software clock calibration to compensate crystal deviation due to temperature
- Automatic leap year compensation
- Operating temperature of -40 to 85°C
- Packaging includes a 28-lead SOIC and SNAPHAT® top (to be ordered separately; 3.3 V to 5.0 V supply voltage only)
- RoHS compliant
  - Lead-free second level interconnect



Contents M41T11

## **Contents**

1	Desc	cription			5
2	Ope	ration .			8
	2.1	2-wire	bus characteristics		8
		2.1.1	Bus not busy		8
		2.1.2	Start data transfer		8
		2.1.3	Stop data transfer		9
		2.1.4	Data valid		9
		2.1.5	Acknowledge	!	9
	2.2	Read r	mode		1
	2.3	Write n	node	1:	3
	2.4	Data re	etention mode		3
3	Cloc	k opera	tion	14	4
	3.1	Clock	calibration	18	5
	3.2	Output	driver pin	10	6
	3.3	Preferr	ed initial power-on defaults		6
4	Maxi	imum ra	tings		8
5	DC a	and AC p	parameters	19	9
6	Pack	age me	chanical data	22	2
7	Part	number	ring	2	7
8	Envi	ronmen	tal information	28	8
9	Revi	sion his	story	29	9

M41T11 List of tables

# List of tables

Table 1.	Signal names	. 6
Table 2.	AC characteristics	
Table 3.	Register map	15
Table 4.	Absolute maximum ratings	18
Table 5.	Operating and AC measurement conditions	19
Table 6.	Capacitance	20
Table 7.	DC characteristics	20
Table 8.	Crystal electrical characteristics	20
Table 9.	Power down/up AC characteristics	21
Table 10.	Power down/up trip points DC characteristics	21
Table 11.	SO8 – 8-lead plastic small outline (150 mils body width) package mechanical data	23
Table 12.	SOH28 – 28-lead plastic small outline, battery SNAPHAT® package mechanical data	24
Table 13.	SH – 4-pin SNAPHAT® housing for 48 mAh battery & crystal, package mechanical data.	
Table 14.	SH – 4-pin SNAPHAT® housing for 120 mAh battery & crystal, package mech. data	26
Table 15.	Ordering information scheme	27
Table 16.	SNAPHAT® battery table	27
Table 17.	Revision history	29

5/

List of figures M41T11

# **List of figures**

Figure 1.	Logic diagram	5
Figure 2.	8-pin SOIC connections	
Figure 3.	28-pin SOIC connections	
Figure 4.	Block diagram	
Figure 5.	Serial bus data transfer sequence	9
Figure 6.	Acknowledgement sequence	10
Figure 7.	Bus timing requirements sequence	10
Figure 8.	Slave address location	12
Figure 9.	Read mode sequence	12
Figure 10.	Alternate read mode sequence	12
Figure 11.	Write mode sequence	13
Figure 12.	Crystal accuracy across temperature	17
Figure 13.	Clock calibration	17
Figure 14.	AC testing input/output waveform	19
Figure 15.	Power down/up mode AC waveforms	21
Figure 16.	SO8 – 8-lead plastic small outline package outline	
Figure 17.	SOH28 – 28-lead plastic small outline, battery SNAPHAT® package outline	
Figure 18.	SH – 4-pin SNAPHAT® housing for 48 mAh battery & crystal package outline	
Figure 19.	SH – 4-pin SNAPHAT <sup>®</sup> housing for 120 mAh battery & crystal, package outline	26
Figure 20	Recycling symbols	28

M41T11 Description

#### 1 **Description**

The M41T11is a low-power serial real time clock with 56 bytes of NVRAM. A built-in 32.768 kHz oscillator (external crystal controlled) and the first 8 bytes of the RAM are used for the clock/calendar function and are configured in binary coded decimal (BCD) format. Addresses and data are transferred serially via a two-line bidirectional bus. The built-in address register is incremented automatically after each write or read data byte.

The M41T11 clock has a built-in power sense circuit which detects power failures and automatically switches to the battery supply during power failures. The energy needed to sustain the RAM and clock operations can be supplied from a small lithium coin cell.

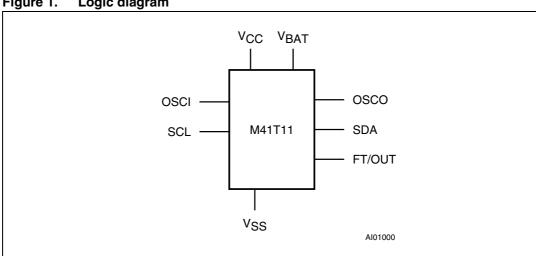
Typical data retention time is in excess of 5 years with a 50 mA/h 3 V lithium cell. The M41T11 is supplied in 8-lead plastic small outline package or 28-lead SNAPHAT® package.

The 28-pin, 330 mil SOIC provides sockets with gold plated contacts at both ends for direct connection to a separate SNAPHAT housing containing the battery and crystal. The unique design allows the SNAPHAT battery package to be mounted on top of the SOIC package after the completion of the surface mount process. Insertion of the SNAPHAT housing after reflow prevents potential battery and crystal damage due to the high temperatures required for device surface-mounting. The SNAPHAT housing is keyed to prevent reverse insertion. The SOIC and battery/crystal packages are shipped separately in plastic anti-static tubes or in tape & reel form.

For the 28-lead SOIC, the battery/crystal package (i.e. SNAPHAT) part number is "M4Txx-BR12SH" (see Table 16 on page 27).

Caution:

Do not place the SNAPHAT battery/crystal package "M4Txx-BR12SH" in conductive foam since this will drain the lithium button-cell battery.



Description M41T11

Table 1. Signal names

OSCI	Oscillator input
OCSO	Oscillator output
FT/OUT	Frequency test/output driver (open drain)
SDA	Serial data address input/output
SCL	Serial clock
V <sub>BAT</sub>	Battery supply voltage
V <sub>CC</sub>	Supply voltage
V <sub>SS</sub>	Ground

Figure 2. 8-pin SOIC connections

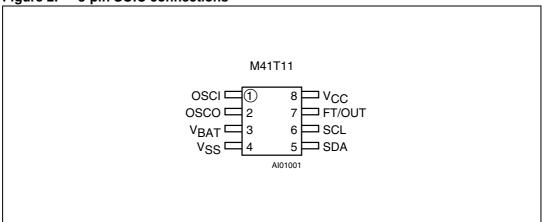
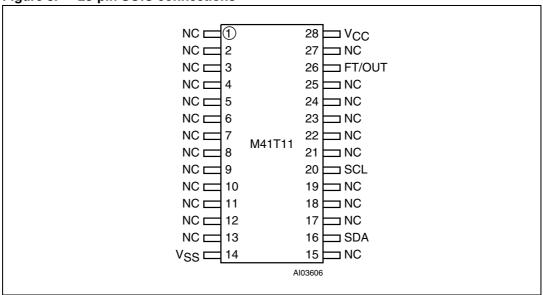
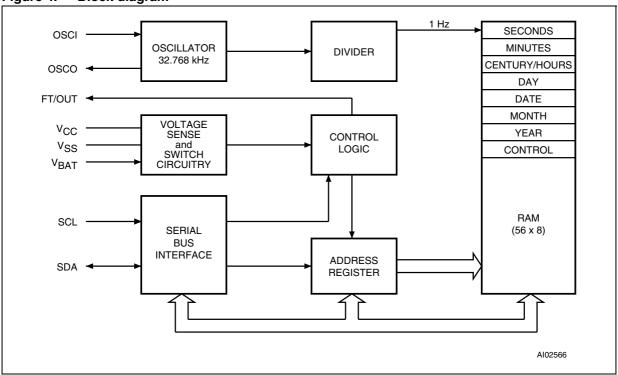


Figure 3. 28-pin SOIC connections



M41T11 Description

Figure 4. Block diagram



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Operation M41T11

## 2 Operation

The M41T11 clock operates as a slave device on the serial bus. Access is obtained by implementing a start condition followed by the correct slave address (D0h). The 64 bytes contained in the device can then be accessed sequentially in the following order:

- 1<sup>st</sup> byte: seconds register
- 2<sup>nd</sup> byte: minutes register
- 3<sup>rd</sup> byte: century/hours register
- 4<sup>th</sup> byte: day register
- 5<sup>th</sup> byte: date register
- 6<sup>th</sup> byte: month register
- 7<sup>th</sup> byte: years register
- 8<sup>th</sup> byte: control register
- 9<sup>th</sup> 64<sup>th</sup> bytes: RAM

The M41T11 clock continually monitors  $V_{CC}$  for an out of tolerance condition. Should  $V_{CC}$  fall below  $V_{SO}$ , the device terminates an access in progress and resets the device address counter. Inputs to the device will not be recognized at this time to prevent erroneous data from being written to the device from an out of tolerance system. When  $V_{CC}$  falls below  $V_{SO}$ , the device automatically switches over to the battery and powers down into an ultra low current mode of operation to conserve battery life. Upon power-up, the device switches from battery to  $V_{CC}$  at  $V_{SO}$  and recognizes inputs.

#### 2.1 2-wire bus characteristics

This bus is intended for communication between different ICs. It consists of two lines: one bidirectional for data signals (SDA) and one for clock signals (SCL). Both the SDA and the SCL lines must be connected to a positive supply voltage via a pull-up resistor.

The following protocol has been defined:

- Data transfer may be initiated only when the bus is not busy.
- During data transfer, the data line must remain stable whenever the clock line is high.
- Changes in the data line while the clock line is high will be interpreted as control signals.

Accordingly, the following bus conditions have been defined:

### 2.1.1 Bus not busy

Both data and clock lines remain high.

#### 2.1.2 Start data transfer

A change in the state of the data line, from high to low, while the clock is high, defines the START condition.

M41T11 Operation

#### 2.1.3 Stop data transfer

A change in the state of the data line, from low to high, while the clock is high, defines the STOP condition.

#### 2.1.4 Data valid

The state of the data line represents valid data when after a start condition, the data line is stable for the duration of the high period of the clock signal. The data on the line may be changed during the low period of the clock signal. There is one clock pulse per bit of data.

Each data transfer is initiated with a start condition and terminated with a stop condition. The number of data bytes transferred between the start and stop conditions is not limited. The information is transmitted byte-wide and each receiver acknowledges with a ninth bit.

By definition, a device that gives out a message is called "transmitter", the receiving device that gets the message is called "receiver". The device that controls the message is called "master". The devices that are controlled by the master are called "slaves".

#### 2.1.5 Acknowledge

Each byte of eight bits is followed by one acknowledge bit. This acknowledge bit is a low level put on the bus by the receiver, whereas the master generates an extra acknowledge related clock pulse.

A slave receiver which is addressed is obliged to generate an acknowledge after the reception of each byte. Also, a master receiver must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter.

The device that acknowledges has to pull down the SDA line during the acknowledge clock pulse in such a way that the SDA line is a stable low during the high period of the acknowledge related clock pulse. Of course, setup and hold times must be taken into account. A master receiver must signal an end-of-data to the slave transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this case, the transmitter must leave the data line high to enable the master to generate the STOP condition.

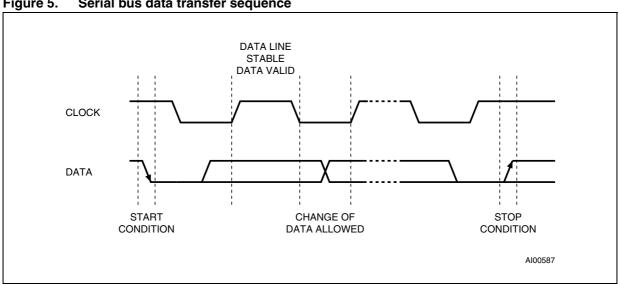


Figure 5. Serial bus data transfer sequence

Operation M41T11

Figure 6. Acknowledgement sequence

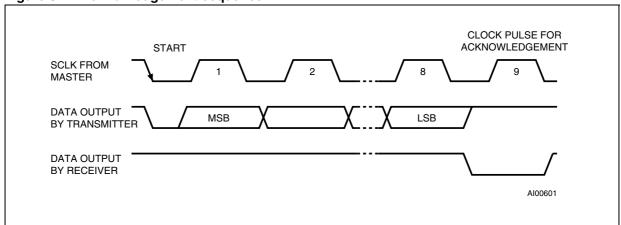
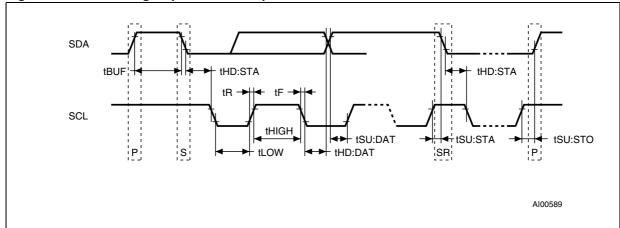


Figure 7. Bus timing requirements sequence



1. P = STOPand S = START

M41T11 Operation

Table 2. AC characteristics

Symbol	Parameter <sup>(1)</sup>	Min	Max	Unit
f <sub>SCL</sub>	SCL clock frequency	0	100	kHz
t <sub>LOW</sub>	Clock low period	4.7		μs
t <sub>HIGH</sub>	Clock high period	4		μs
t <sub>R</sub>	SDA and SCL rise time		1	μs
t <sub>F</sub>	SDA and SCL fall time		300	ns
t <sub>HD:STA</sub>	START condition hold time (after this period the first clock pulse is generated)	4		μs
t <sub>SU:STA</sub>	START condition setup time (only relevant for a repeated start condition)	4.7		μs
t <sub>SU:DAT</sub>	Data setup time	250		ns
t <sub>HD:DAT</sub> <sup>(2)</sup>	Data hold time	0		μs
t <sub>SU:STO</sub>	STOP condition setup time	4.7		μs
t <sub>BUF</sub>	Time the bus must be free before a new transmission can start	4.7		μs

<sup>1.</sup> Valid for ambient operating temperature:  $T_A = -40$  to 85°C;  $V_{CC} = 2.0$  to 5.5 V (except where noted).

#### 2.2 Read mode

In this mode, the master reads the M41T11 slave after setting the slave address (see Figure 8). Following the write mode control bit ( $R/\overline{W}=0$ ) and the acknowledge bit, the word address  $A_n$  is written to the on-chip address pointer. Next the START condition and slave address are repeated, followed by the READ mode control bit ( $R/\overline{W}=1$ ). At this point, the master transmitter becomes the master receiver. The data byte which was addressed will be transmitted and the master receiver will send an acknowledge bit to the slave transmitter (see Figure 9). The address pointer is only incremented on reception of an acknowledge bit. The M41T11 slave transmitter will now place the data byte at address  $A_n+1$  on the bus. The master receiver reads and acknowledges the new byte and the address pointer is incremented to  $A_n+2$ .

This cycle of reading consecutive addresses will continue until the master receiver sends a STOP condition to the slave transmitter.

An alternate READ mode may also be implemented, whereby the master reads the M41T11 slave without first writing to the (volatile) address pointer. The first address that is read is the last one stored in the pointer (see *Figure 10 on page 12*).

<sup>2.</sup> Transmitter must internally provide a hold time to bridge the undefined region (300 ns max.) of the falling edge of SCL.

Operation M41T11

Figure 8. Slave address location

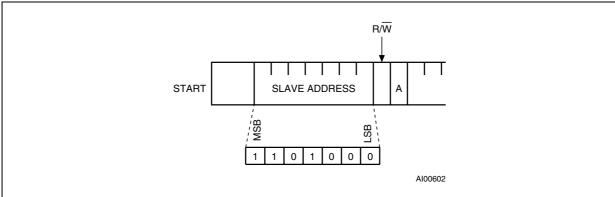


Figure 9. Read mode sequence

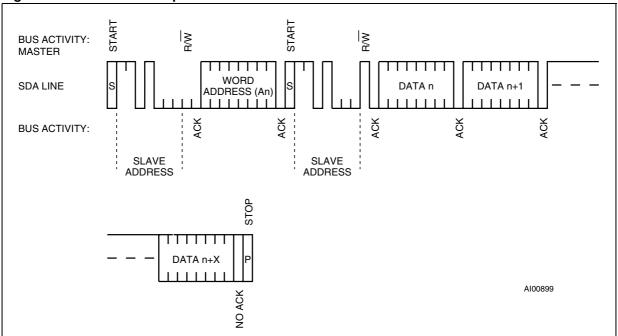
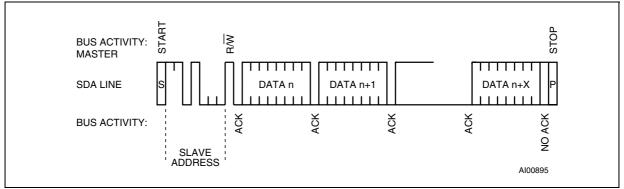


Figure 10. Alternate read mode sequence



M41T11 Operation

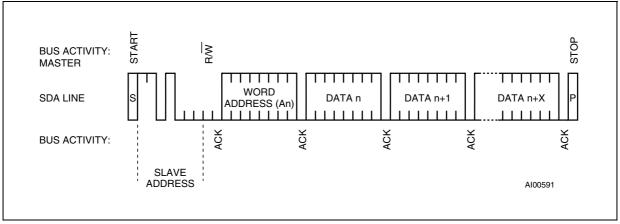
### 2.3 Write mode

In this mode the master transmitter transmits to the M41T11 slave receiver. Bus protocol is shown in *Figure 11*. Following the START condition and slave address, a logic '0' ( $R/\overline{W} = 0$ ) is placed on the bus and indicates to the addressed device that word address An will follow and is to be written to the on-chip address pointer. The data word to be written to the memory is strobed in next and the internal address pointer is incremented to the next memory location within the RAM on the reception of an acknowledge clock. The M41T11 slave receiver will send an acknowledge clock to the master transmitter after it has received the slave address and again after it has received the word address and each data byte.

### 2.4 Data retention mode

With valid  $V_{CC}$  applied, the M41T11 can be accessed as described above with read or write cycles. Should the supply voltage decay, the M41T11 will automatically deselect, write protecting itself when  $V_{CC}$  falls (see *Figure 15*).

Figure 11. Write mode sequence



Clock operation M41T11

## 3 Clock operation

The eight byte clock register (see *Table 3*) is used to both set the clock and to read the date and time from the clock, in a binary coded decimal format. Seconds, minutes, and hours are contained within the first three registers. Bits D6 and D7 of clock register 2 (hours register) contain the CENTURY ENABLE bit (CEB) and the CENTURY bit (CB). Setting CEB to a '1' will cause CB to toggle, either from '0' to '1' or from '1' to '0' at the turn of the century (depending upon its initial state). If CEB is set to a '0', CB will not toggle. Bits D0 through D2 of register 3 contain the day (day of week). Registers 4, 5 and 6 contain the date (day of month), month and years. The final register is the control register (this is described in the clock calibration section). Bit D7 of register 0 contains the STOP bit (ST). Setting this bit to a '1' will cause the oscillator to stop. If the device is expected to spend a significant amount of time on the shelf, the oscillator may be stopped to reduce current drain. When reset to a '0' the oscillator restarts within one second.

Note:

In order to guarantee oscillator startup after the initial power-up, set the ST bit to a '1,' then reset this bit to a '0.' This sequence enables a "kick start" circuit which aids the oscillator startup during worst case conditions of voltage and temperature.

The seven clock registers may be read one byte at a time, or in a sequential block. The control register (address location 7) may be accessed independently. Provision has been made to assure that a clock update does not occur while any of the seven clock addresses are being read. If a clock address is being read, an update of the clock registers will be delayed by 250 ms to allow the read to be completed before the update occurs. This will prevent a transition of data during the read.

Note:

This 250 ms delay affects only the clock register update and does not alter the actual clock time.

M41T11 Clock operation

Table 3. Register map<sup>(1)</sup>

Address				D	ata				Function/range BCD format	
Address	D7	D6	D5	D4	D3	D2	D1	D0		
0	ST	10	) secon	ds		Sec	onds		Seconds	00-59
1	Х	10	10 minutes Minutes		Minutes			Minutes	00-59	
2	CEB <sup>(2)</sup>	СВ	10 h	ours	Hours		Century/hours	0-1/00-23		
3	Х	Х	Х	Х	Х		Day		Day	01-07
4	Х	Х	10 (	date		Date		Date	01-31	
5	Х	Х	Х	10 M.	Month		Month	01-12		
6		10 ye	ears		Years		Year	00-99		
7	OUT	FT	S		Calibration		Control			

Keys:
S = SIGN bit
FT = FREQUENCY TEST bit
ST = STOP bit
OUT = Output level
X = Don't care
CEB = Century enable bit
CB = Century bit

2. When CEB is set to '1', CB will toggle from '0' to '1' or from '1' to '0' every 100 years (dependent upon the initial value set). When CEB is set to '0', CB will not toggle. When CEB is set to '1', CB will toggle from '0' to '1' or from '1' to '0' every 100 years (dependent upon the initial value set). When CEB is set to '0', CB will not toggle.

### 3.1 Clock calibration

The M41T11 is driven by a quartz controlled oscillator with a nominal frequency of 32,768 Hz. The devices are tested not to exceed 35 ppm (parts per million) oscillator frequency error at  $25^{\circ}$ C, which equates to about  $\pm 1.53$  minutes per month. With the calibration bits properly set, the accuracy of each M41T11 improves to better than  $\pm 2$  ppm at  $25^{\circ}$ C.

The oscillation rate of any crystal changes with temperature (see *Figure 12 on page 17*). Most clock chips compensate for crystal frequency and temperature shift error with cumbersome trim capacitors. The M41T11 design, however, employs periodic counter correction. The calibration circuit adds or subtracts counts from the oscillator divider circuit at the divide by 256 stage, as shown in *Figure 13 on page 17*. The number of times pulses are blanked (subtracted, negative calibration) or split (added, positive calibration) depends upon the value loaded into the five-bit calibration byte found in the control register. Adding counts speeds the clock up, subtracting counts slows the clock down.

The calibration byte occupies the five lower order bits (D4-D0) in the control register (addr 7). This byte can be set to represent any value between 0 and 31 in binary form. Bit D5 is a sign bit; '1' indicates positive calibration, '0' indicates negative calibration. Calibration occurs within a 64 minute cycle. The first 62 minutes in the cycle may, once per minute, have one second either shortened by 128 or lengthened by 256 oscillator cycles. If a binary '1' is loaded into the register, only the first 2 minutes in the 64 minute cycle will be modified; if a binary 6 is loaded, the first 12 will be affected, and so on.

Therefore, each calibration step has the effect of adding 512 or subtracting 256 oscillator cycles for every 125,829,120 actual oscillator cycles, that is +4.068 or -2.034 ppm of

Clock operation M41T11

adjustment per calibration step in the calibration register. Assuming that the oscillator is in fact running at exactly 32,768 Hz, each of the 31 increments in the calibration byte would represent +10.7 or -5.35 seconds per month which corresponds to a total range of +5.5 or -2.75 minutes per month.

Two methods are available for ascertaining how much calibration a given M41T11 may require. The first involves simply setting the clock, letting it run for a month and comparing it to a known accurate reference (like WWV broadcasts). While that may seem crude, it allows the designer to give the end user the ability to calibrate his clock as his environment may require, even after the final product is packaged in a non-user serviceable enclosure. All the designer has to do is provide a simple utility that accessed the calibration byte.

The second approach is better suited to a manufacturing environment, and involves the use of some test equipment. When the frequency test (FT) bit, the seventh-most significant bit in the control register, is set to a '1', and the oscillator is running at 32,768 Hz, the FT/OUT pin of the device will toggle at 512 Hz. Any deviation from 512 Hz indicates the degree and direction of oscillator frequency shift at the test temperature.

For example, a reading of 512.01024 Hz would indicate a +20 ppm oscillator frequency error, requiring a -10(XX001010) to be loaded into the calibration byte for correction. Note that setting or changing the calibration byte does not affect the frequency test output frequency.

### 3.2 Output driver pin

When the FT bit is not set, the FT/OUT pin becomes an output driver that reflects the contents of D7 of the control register. In other words, when D6 of location 7 is a zero and D7 of location 7 is a zero and then the FT/OUT pin will be driven low.

**Note:** The FT/OUT pin is open drain which requires an external pull-up resistor.

### 3.3 Preferred initial power-on defaults

Upon initial application of power to the device, the FT bit will be set to a '0' and the OUT bit will be set to a '1'. All other register bits will initially power on in a random state.

M41T11 Clock operation

Figure 12. Crystal accuracy across temperature

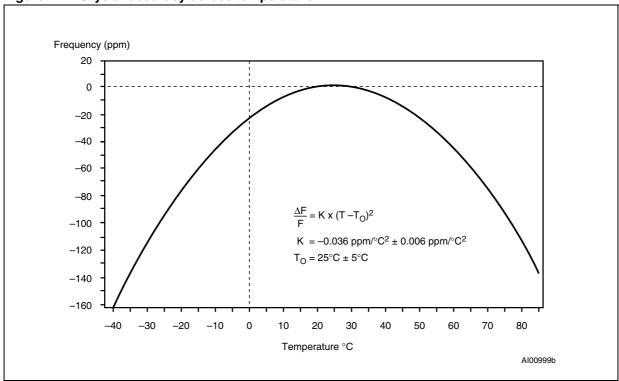
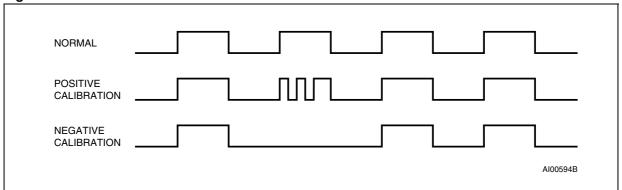


Figure 13. Clock calibration



Maximum ratings M41T11

# 4 Maximum ratings

Stressing the device above the rating listed in the absolute maximum ratings table may cause permanent damage to the device. These are stress ratings only and operation of the device at these or any other conditions above those indicated in the operating sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Refer also to the STMicroelectronics SURE Program and other relevant quality documents.

Table 4. Absolute maximum ratings

Symbol	Parameter		Value	Unit
T <sub>A</sub>	Ambient operating temperature	-40 to 85	°C	
т	Storage temperature (V <sub>CC</sub> off, oscillator off)	SNAPHAT®	-40 to 85	°C
T <sub>STG</sub>	Storage temperature (V <sub>CC</sub> on, oscillator on)	SOIC	-55 to 125	C
T <sub>SLD</sub> <sup>(1)</sup>	Lead solder temperature for 10 seconds		260	°C
V <sub>IO</sub>	Input or output voltages	-0.3 to 7	V	
V <sub>CC</sub>	Supply voltage	-0.3 to 7	V	
I <sub>O</sub>	Output current	20	mA	
$P_{D}$	Power dissipation	0.25	W	

Lead-free (Pb-free) lead finish: reflow at peak temperature of 260°C (the time above 255°C must not exceed 30 seconds).

Caution: Negative undershoots below -0.3 V are not allowed on any pin while in the battery backup

mode.

**Caution:** Do NOT wave solder SOIC to avoid damaging SNAPHAT<sup>®</sup> sockets.

## 5 DC and AC parameters

This section summarizes the operating and measurement conditions, as well as the DC and AC characteristics of the device. The parameters in the following DC and AC characteristic tables are derived from tests performed under the measurement conditions listed in *Table 5:* Operating and AC measurement conditions. Designers should check that the operating conditions in their projects match the measurement conditions when using the quoted parameters.

Table 5. Operating and AC measurement conditions<sup>(1)</sup>

operating and the measurement contain	- Processing and a second a second and a second a second and a second a second and a second a second a second a second and						
Parameter	M41T11	Unit					
Supply voltage (V <sub>CC</sub> )	2.0 to 5.5 <sup>(2)</sup>	V					
Ambient operating temperature (T <sub>A</sub> )	-40 to 85	°C					
Load capacitance (C <sub>L</sub> )	100	pF					
Input rise and fall times	≤ 50	ns					
Input pulse voltages	0.2V <sub>CC</sub> to 0.8V <sub>CC</sub>	V					
Input and output timing ref. voltages	0.3V <sub>CC</sub> to 0.7V <sub>CC</sub>	V					

- 1. Output Hi-Z is defined as the point where data is no longer driven.
- 2. Supply voltage for SOH28 is 3.3 V to 5.5 V.

Figure 14. AC testing input/output waveform

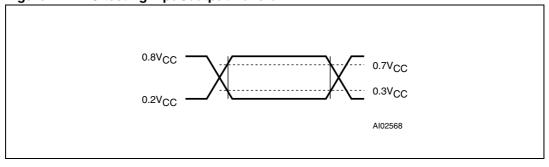


Table 6. Capacitance

Symbol	Parameter <sup>(1)(2)</sup>	Min	Max	Unit
C <sub>IN</sub>	Input capacitance (SCL)		7	pF
C <sub>OUT</sub> <sup>(3)</sup>	Output capacitance (SDA, FT/OUT)		10	pF
t <sub>LP</sub>	Low-pass filter input time constant (SDA and SCL)	250	1000	ns

- 1. Effective capacitance measured with power supply at 5 V; sampled only, not 100% tested.
- 2. At 25°C, f = 1 MHz.
- 3. Outputs deselected.

Table 7. DC characteristics

Symbol	Parameter	Test Condition <sup>(1)</sup>	Min	Тур	Max	Unit
I <sub>LI</sub>	Input leakage current	$0V \le V_{IN} \le V_{CC}$			±1	μΑ
I <sub>LO</sub>	Output leakage current	$0V \le V_{OUT} \le V_{CC}$			±1	μΑ
I <sub>CC1</sub>	Supply current	Switch frequency = 100 kHz			300	μΑ
I <sub>CC2</sub>	Supply current (standby)	SCL, SDA = $V_{CC} - 0.3 \text{ V}$			70	μΑ
V <sub>IL</sub>	Input low voltage		-0.3		0.3V <sub>CC</sub>	٧
V <sub>IH</sub>	Input high voltage		0.7V <sub>CC</sub>		V <sub>CC</sub> + 0.5	V
V <sub>OL</sub>	Output low voltage	I <sub>OL</sub> = 3 mA			0.4	V
	Pull-up supply voltage (open drain)	FT/OUT			5.5	V
V <sub>BAT</sub> <sup>(2)</sup>	Battery supply voltage		2.5 <sup>(3)</sup>	3	3.5 <sup>(4)</sup>	٧
I <sub>BAT</sub>	Battery supply current	$T_A = 25$ °C, $V_{CC} = 0$ V, oscillator ON, $V_{BAT} = 3$ V		0.8	1	μΑ

- 1. Valid for ambient operating temperature:  $T_A = -40$  to 85°C;  $V_{CC} = 2.0$  to 5.5 V (except where noted).
- 2. STMicroelectronics recommends the RAYOVAC BR1225 or BR1632 (or equivalent) as the battery supply.
- 3. After switchover ( $V_{SO}$ ),  $V_{BAT}$ (min) can be 2.0 V for crystal with  $R_S$  = 40 K $\Omega$ .
- 4. For rechargeable back-up,  $V_{BAT}(max)$  may be considered  $V_{CC}$ .

Table 8. Crystal electrical characteristics

Symbol	Parameter <sup>(1)(2)(3)</sup>	Min	Тур	Max	Unit
f <sub>O</sub>	Resonant frequency		32.768		kHz
R <sub>S</sub>	Series resistance			60	kΩ
CL	Load capacitance		12.5		pF

These values are externally supplied if using the SO8 package. STMicroelectronics recommends the KDS DT-38: 1TA/1TC252E127, Tuning Fork Type (thru-hole) or the DMX-26S: 1TJS125FH2A212, (SMD) quartz crystal for industrial temperature operations. KDS can be contacted at kouhou@kdsj.co.jp or http://www.kdsj.co.jp for further information on this crystal type.

3. All SNAPHAT<sup>®</sup> battery:crystal tops meet these specifications.

<sup>2.</sup> Load capacitors are integrated within the M41T11. Circuit board layout considerations for the 32.768 kHz crystal of minimum trace lengths and isolation from RF generating signals should be taken into account.

Figure 15. Power down/up mode AC waveforms

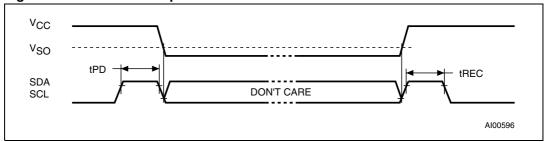


Table 9. Power down/up AC characteristics

Symbol	Parameter <sup>(1)(2)</sup>	Min	Max	Unit
t <sub>PD</sub>	SCL and SDA at V <sub>IH</sub> before power down	0		ns
t <sub>REC</sub>	SCL and SDA at V <sub>IH</sub> after power up	10		μs

- 1. Valid for ambient operating temperature:  $T_A = -40$  to 85°C;  $V_{CC} = 2.0$  to 5.5 V (except where noted).
- 2.  $V_{CC}$  fall time should not exceed 5 mV/ $\mu$ s.

Table 10. Power down/up trip points DC characteristics

Symbol	Parameter <sup>(1)(2)</sup>	Min	Тур	Max <sup>(3)</sup>	Unit
V <sub>SO</sub> <sup>(4)</sup>	Battery backup switchover voltage	V <sub>BAT</sub> - 0.80	V <sub>BAT</sub> – 0.50	V <sub>BAT</sub> – 0.30	V

- 1. Valid for ambient operating temperature:  $T_A = -40$  to  $85^{\circ}C$ ;  $V_{CC} = 2.0$  to 5.5 V (except where noted).
- 2. All voltages referenced to  $V_{\mbox{\footnotesize SS}}$ .
- In 3.3 V application, if initial battery voltage is ≥ 3.4 V, it may be necessary to reduce battery voltage (i.e., through wave soldering the battery) in order to avoid inadvertent switchover/deselection for V<sub>CC</sub> 10% operation.
- 4. Switchover and deselect point.

577

# 6 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: www.st.com. ECOPACK<sup>®</sup> is an ST trademark.

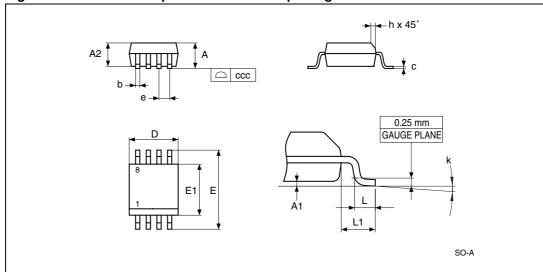


Figure 16. SO8 – 8-lead plastic small outline package outline

Table 11. SO8 – 8-lead plastic small outline (150 mils body width) package mechanical data

Symbol	millimeters			inches		
	Тур	Min	Max	Тур	Min	Max
А			1.75			0.069
A1		0.10	0.25		0.004	0.010
A2		1.25			0.049	
b		0.28	0.48		0.011	0.019
С		0.17	0.23		0.007	0.009
ccc			0.10			0.004
D	4.90	4.80	5.00	0.193	0.189	0.197
E	6.00	5.80	6.20	0.236	0.228	0.244
E1	3.90	3.80	4.00	0.154	0.150	0.157
е	1.27	_	-	0.050	_	_
h		0.25	0.50		0.010	0.020
k		0°	8°		0°	8°
L	_	0.40	1.27		0.016	0.050
L1	1.04			0.041		

577

Figure 17. SOH28 – 28-lead plastic small outline, battery SNAPHAT® package outline

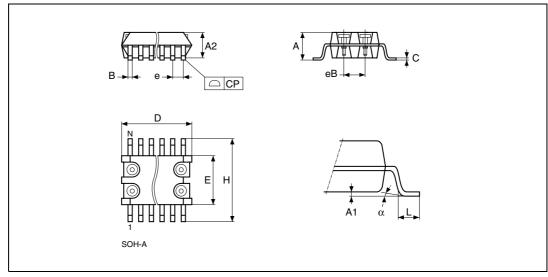


Table 12. SOH28 – 28-lead plastic small outline, battery SNAPHAT<sup>®</sup> package mechanical data

Symb	mm			inches		
	Тур	Min	Max	Тур	Min	Max
Α			3.05			0.120
A1		0.05	0.36		0.002	0.014
A2		2.34	2.69		0.092	0.106
В		0.36	0.51		0.014	0.020
С		0.15	0.32		0.006	0.012
D		17.71	18.49		0.697	0.728
E		8.23	8.89		0.324	0.350
е	1.27	_	_	0.050	-	_
eB		3.20	3.61		0.126	0.142
Н		11.51	12.70		0.453	0.500
L		0.41	1.27		0.016	0.050
α		0°	8°		0°	8°
N		28			28	
СР			0.10			0.004

24/30

Figure 18. SH-4-pin SNAPHAT $^{\circledR}$  housing for 48 mAh battery & crystal package outline

Table 13. SH – 4-pin SNAPHAT<sup>®</sup> housing for 48 mAh battery & crystal, package mechanical data

Symb	mm			inches		
			r		mones	1
	Тур	Min	Max	Тур	Min	Max
Α			9.78			0.385
A1		6.73	7.24		0.265	0.285
A2		6.48	6.99		0.255	0.275
A3			0.38			0.015
В		0.46	0.56		0.018	0.022
D		21.21	21.84		0.835	0.860
Е		14.22	14.99		0.560	0.590
eA		15.55	15.95		0.612	0.628
eB		3.20	3.61		0.126	0.142
L		2.03	2.29		0.080	0.090

**577** 

Figure 19. SH – 4-pin SNAPHAT<sup>®</sup> housing for 120 mAh battery & crystal, package outline

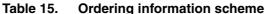
Table 14. SH – 4-pin SNAPHAT® housing for 120 mAh battery & crystal, package mech. data

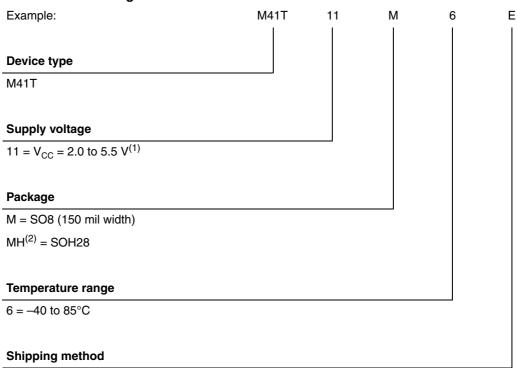
Symb	mm			inches		
	Тур	Min	Max	Тур	Min	Max
Α			10.54			0.415
A1		8.00	8.51		0.315	0.335
A2		7.24	8.00		0.285	0.315
A3			0.38			0.015
В		0.46	0.56		0.018	0.022
D		21.21	21.84		0.835	0.860
E		17.27	18.03		0.680	0.710
eA		15.55	15.95		0.612	0.628
eB		3.20	3.61		0.126	0.142
L		2.03	2.29		0.080	0.090

**577** 

M41T11 Part numbering

# 7 Part numbering





E = ECOPACK® package, tubes

 $F = ECOPACK^{(R)}$  package, tape & reel

- 1. SOH28 supply voltage is 3.3 V to 5.5 V.
- 2. The SOIC package (SOH28) requires the SNAPHAT<sup>®</sup> battery package which is ordered separately under the part number "M4Txx-BR12SHx" in plastic tube or "M4Txx-BR12SHxTR" in tape & reel form (see *Table 16*).

#### Caution:

Do not place the SNAPHAT battery package "M4TXX-BR12SH" in conductive foam as it will drain the lithium button-cell battery.

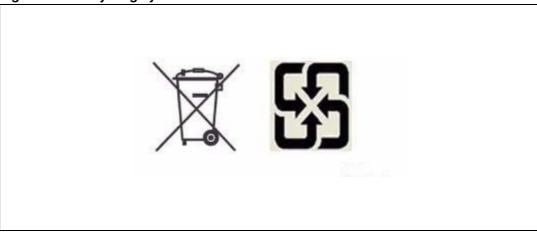
For other options, or for more information on any aspect of this device, please contact the ST sales office nearest you.

Table 16. SNAPHAT® battery table

Part Number	Description	Package	
M4T28-BR12SH	Lithium battery (48 mAh) SNAPHAT	SH	
M4T32-BR12SH	Lithium battery (120 mAh) SNAPHAT	SH	

### 8 Environmental information

Figure 20. Recycling symbols



This product contains a non-rechargeable lithium (lithium carbon monofluoride chemistry) button cell battery fully encapsulated in the final product.

Recycle or dispose of batteries in accordance with the battery manufacturer's instructions and local/national disposal and recycling regulations.

Please refer to the following web site address for additional information regarding compliance statements and waste recycling.

Go to www.st.com/rtc, then select "Lithium Battery Recycling" from "Related Topics".

M41T11 Revision history

# 9 Revision history

Table 17. Revision history

Date	Revision	Changes			
Mar-1999	1	First issue			
23-Dec-1999 1.1		SOH28 package added			
25-Jul-2000	1.2	Crystal electrical characteristics: R <sub>S</sub> Max changed ( <i>Table 8</i> )			
12-Dec-2000	1.3	Edit V <sub>SO</sub> ( <i>Table 10</i> )			
24-Jan-2001	2	Reformatted			
27-Feb-2001	3	Document status changed			
17-Jul-2001	3.1	Change to DC and AC characteristics ( <i>Table 7</i> , <i>Table</i> ); added temp/voltage info. to ( <i>Table 6</i> , <i>Table 7</i> , <i>Table 8</i> , <i>Table 9</i> , <i>Table 10</i> ); added SNAPHAT battery table ( <i>Table 16</i> ).			
27-Nov-2001	3.2	Features, (page 1); DC characteristics ( <i>Table 7</i> ); crystal electrical ( <i>Table 8</i> ); power down/up trip points ( <i>Table 10</i> ) changes; add table footnotes ( <i>Table 5</i> , <i>Table 10</i> , <i>Table 15</i> )			
21-Jan-2002	3.3	Fix table footnotes ( <i>Table 7</i> , <i>Table 8</i> )			
01-May-2002	3.4	Modify reflow time and temperature footnote (Table 4)			
03-Jul-2002 3.5		Modify "Clock operation" text, crystal electrical characteristics table footnote ( <i>Table 8</i> )			
07-Nov-2002	3.6	Correct figure name in Features on page 1;			
15-Jun-2004	4	Reformatted; added Lead-free information; updated characteristics (Figure 12; Table 4, Table 7, Table 15)			
14-Dec-2004	5	Correct footnote (Table 8)			
22-Aug-2006	6	Changed document to new template; changed title on page 1; re-ordered text and amalgamated figures in <i>Features on page 1</i> ; updated package mechanical data in <i>Section 6: Package mechanical data</i> ; amended footnotes in <i>Table</i> and <i>Table 9</i> ; <i>Table 15</i> ecopack compliant; small text changes for entire document			
03-Oct-2007 7 Sec		Added lead-free second level interconnect information to cover page and Section 6: Package mechanical data; some text changes; updated Table 4.			
02-May-2008	8	Updated Figure 16, Table 11, 15.			
08-Jan-2009	9	Updated Table 4, Section 6: Package mechanical data; added Section 8: Environmental information.			

29/30

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577